HPC to Enable Next-generation Low-temperature Waste Heat Recovery

Vivek M. Rao, Marc-Olivier Delchini, Min-Tsung Kao, Prashant K. Jain & Swami Subramanian **Oak Ridge National Laboratory (ORNL) & Eaton Corporation**

Project Objectives

US manufacturing industry fails to recover an estimated 900 trillion BTUs of low-temperature (<230°C) waste heat from its processes each year.

Recovery is challenging with conventional heat exchangers because of their low thermal efficiencies, large footprints, and lack of economics (high setup and operational costs). • Direct-contact heat exchanger technology can

- provide
 - Low-cost, compact, longer-lifetime, high efficiency waste heat recovery systems utilizing a low-temperature organic Rankine cycle.

Technical Innovation

Advanced multi-phase computational fluid dynamics (CFD) models are developed to design a direct-contact heat exchanger and separator (DCHXS) system for low-temperature waste heat recovery.



This research was supported by the High Performance Computing for Manufacturing Program (HPC4Mfg), managed by the U.S. Department of Energy Advanced Manufacturing Office within the Energy Efficiency and Renewable Energy Office. It was performed under the auspices of the U.S. Department of Energy by Oak Ridge National Laboratory under contract DE-AC05-000R22725.

Technical Approach

3D transient 3-phase CFD models were developed for water (liquid) and n-pentane (both liquid and vapor) in STAR-CCM+ using a multi-Eulerian framework with Volume of fluid (VOF) approach using Rohsenow boiling and Schiller-Naumann drag models.



Benchmarking of a 3D CFD model against the experimentally

Results and Accomplishments

HPC-scalable transient CFD model was developed for a highly complex multiphysics flow, heat transfer and phase change problem.



Velocity vectors near the sparger nozzles

Transition

The ORNL CFD models for the optimized baseline DCHXS design will be evaluated for more realistic waste heat parameters and system conditions, provided by the Eaton team.

Budget/Timeline

Timeline: Project Start Date: 06/11/2018 Budget Period End Date: 12/31/2019 **Project End Date:** 12/31/2019

Budge

Overall Bu

Approved Bud

Costs as of 05

*estimated





The baseline DCHXS design will be optimized for increasing the volumetric heat transfer coefficient.

	HPC Metrics	CFD Model
(m/s)	Physical time	240 s
	Solver time step	1 ms
	# CPU cores	1,024
	Wall time per second of physical time	25 min

t	DOE Share	Cost Share	Total	Cost Share %
dget	\$322,000	\$75,000	\$397,000	23.3%
lget (BP-	\$322,000	\$75,000	\$397,000	23.3%
/13/2019	\$159,000	\$45,000*	\$204,000	28.3%

BERKELEY LAB

